

High-Yield Growth and Characterization of $\langle 100 \rangle$ InP p–n Diode Nanowires

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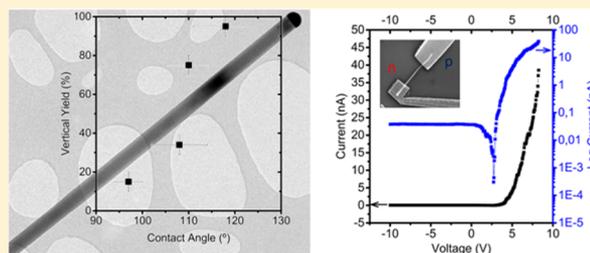
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Supporting Information

ABSTRACT: Semiconductor nanowires are nanoscale structures holding promise in many fields such as optoelectronics, quantum computing, and thermoelectrics. Nanowires are usually grown vertically on $\langle 111 \rangle$ -oriented substrates, while $\langle 100 \rangle$ is the standard in semiconductor technology. The ability to grow and to control impurity doping of $\langle 100 \rangle$ nanowires is crucial for integration. Here, we discuss doping of single-crystalline $\langle 100 \rangle$ nanowires, and the structural and optoelectronic properties of p–n junctions based on $\langle 100 \rangle$ InP nanowires. We describe a novel approach to achieve low resistance electrical contacts to nanowires via a gradual interface based on p-doped InAsP. As a first demonstration in optoelectronic devices, we realize a single nanowire light emitting diode in a $\langle 100 \rangle$ -oriented InP nanowire p–n junction. To obtain high vertical yield, which is necessary for future applications, we investigate the effect of the introduction of dopants on the nanowire growth.

KEYWORDS: Nanowire, indium phosphide, 100, diode, p–n junction



The III–V nanowires (NW) have been shown to provide an ideal platform for the development of nanoscale devices and applications, for example, in quantum computing, energy conversion, and LEDs.^{1–6} Nanowires can be grown in a diverse range of crystalline directions on a wide assortment of substrates with different crystal orientations.^{7,8} The most common NW growth direction is $\langle 111 \rangle$;^{9–11} however, in the electronics industry the $\langle 100 \rangle$ crystal orientation is the technology standard. The $\langle 100 \rangle$ NWs would thus be the best match for present semiconductor fabrication and processing, allowing straightforward integration.¹² A lot of effort has been put in controlling crystal phases in $\langle 111 \rangle$ NWs, which remains challenging.^{13–15} In contrast, undoped $\langle 100 \rangle$ InP NWs always exhibit the pure zincblende (ZB) crystalline structure.^{16–20} Up to now; however, devices based on defect-free $\langle 100 \rangle$ nanowires have not been demonstrated due to the lack of knowledge about intentional doping of single-crystal $\langle 100 \rangle$ NWs. Impurity doping of semiconductors is essential for the functionality of optoelectronic devices.^{21,22} In a recent investigation, we showed Au-catalyzed undoped $\langle 100 \rangle$ InP NW arrays with high vertical yield, obtained by catalyst engineering.²³ In this report, we study the structural and optoelectronic properties of InP $\langle 100 \rangle$

NW-based p–n junctions and investigate the effect of the introduction of dopants during nanowire growth.

We use $\langle 100 \rangle$ InP substrates for nanowire growth. Au droplets act as the catalysts for the vapor–liquid–solid (VLS)²⁴ growth process, while diethyl-zinc (DEZn) and hydrogen sulfide (H_2S) are used as p- and n-dopant precursors during NW growth. Nanowire growth rates in our conditions are approximately 2 nm/s (see Supporting Information S1 for more details). In order to check the possible effect of dopants on the crystalline quality of the NW,^{25–27} we studied p–n junctions based on $\langle 100 \rangle$ InP nanowires by transmission electron microscopy (TEM, see Supporting Information S2). The growth was performed using a Zn-doped substrate. We introduced the DEZn after 1 min of growth and continued growth for 8 min. Subsequently, we switched off the p-dopant and introduced H_2S , growing for 13 min. The NW shown in Figure 1a has a pure ZB crystal structure without planar defects

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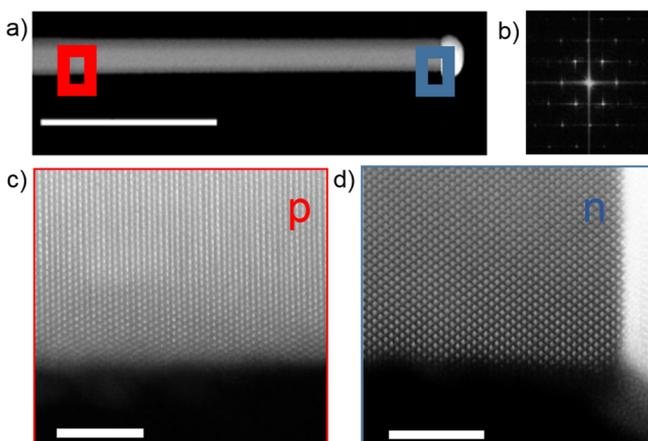


Figure 1. Structural analysis of a $\langle 100 \rangle$ p-n junction NW. (a) HAADF STEM image showing an overview image of a p-n-doped $\langle 100 \rangle$ InP NW. Dopant molar fractions are 4×10^{-6} (DEZn) and 3×10^{-5} (H_2S). Scale-bar is 500 nm. (b) Corresponding FFT image of the NW in panel (a). (c,d) HR-STEM images from the highlighted segments of panel (a), demonstrating the pure zincblende crystalline structure of the NW both for p- and n-doped $\langle 100 \rangle$ InP nanowires. Scale bars are 5 nm.

and flat $\{100\}$ side facets. The corresponding fast Fourier transform (FFT) image in Figure 1b demonstrates the zincblende crystalline structure and confirms the $\langle 100 \rangle$ growth direction. To compare, nanowires grown in the $\langle 111 \rangle$ direction usually show twin planes, and addition of dopants can completely switch the crystal structure from cubic (for Zn) to hexagonal (for S).²⁸ In contrast, the $\langle 100 \rangle$ InP wires have at most only a few stacking faults per nanowire, always close to the NW base.²³ These defects are stacking faults of $\{111\}$ planes. A single stacking fault will introduce a kink in the growth direction of the wire. A pair of stacking faults, as observed most frequently, will leave the growth direction unaltered. These defects are introduced during nucleation when the catalyst particle is still evolving toward its equilibrium shape, as has also been discussed in our previous paper.²³ In our case, thus most of the nanowire and, importantly, also the region of the p-n junction is completely free of defects. In $\langle 100 \rangle$ nanowires, growth proceeds by nucleation of $\{100\}$ rather than $\{111\}$ layers, as in $\langle 111 \rangle$ grown nanowires, where the position of the p-n junction is easily recognized by a transition of the crystal phase from zincblende to wurtzite.²⁸ In the case of $\langle 100 \rangle$ nanowires, a change in stacking sequence from cubic (ABC) to hexagonal would imply the introduction of a WZ layer at an angle of 71° with the original growth direction, making this crystal phase transition unlikely. As a result, in $\langle 100 \rangle$ NW growth the crystal structure is defect-free ZB for both p- and n-doping (see Figure 1c,d).

After structural characterization, we addressed the electronic properties of doped $\langle 100 \rangle$ NWs. The resistance of n-doped NWs, obtained by 4-point probe measurements with Ti/Au metal contacts on a single nanowire, is in the range of a few kilohms (see Supporting Information S3). This behavior is expected, as Ti/Au contacts have been extensively used for characterization of single n-doped InP NWs.²⁹ The measured resistance corresponds to a doping concentration of 10^{18} cm^{-3} . In the case of p-doped NWs we used Ti/Zn/Au contacts, which resulted in nonlinear I - V curves if two-point probe measurements are performed. We attribute the observed nonlinear behavior to the formation of Schottky contacts at the metal-

semiconductor nanowire interface, resulting in a potential barrier, which gives rise to the poor electrical contact. The resistance of the nanowires was thus measured by four-point probe measurements to be several tens of megaohms, which corresponds to a doping concentration of $<10^{17} \text{ cm}^{-3}$ (see Supporting Information S3). Obtaining a low resistive electric contact directly to p-doped InP has previously proven to be a very challenging task.^{30,31} In most cases Zn-based metallization is necessary,^{32,33} making processing unsuitable for most cleanrooms based on III-V materials or silicon. In particular, the highest active hole concentration accessible by Zn doping of InP has been measured in the $2\text{--}5 \times 10^{18} \text{ cm}^{-3}$ range,^{34,35} while the hole concentration necessary to achieve ohmic contacts is predicted to be $5 \times 10^{18} \text{ cm}^{-3}$ with conventional Ti/Pt/Au contacts.³⁶ Furthermore, annealing is often required,³⁷ adding complexity to the structure and to the processing.

In order to avoid these drawbacks, we developed a contact area that consists of an axial extension of the p-doped InP with p-doped $\text{InAs}_x\text{P}_{1-x}$, where the As content is increased gradually in a continuous linear progression during 15 min of growth until AsH_3 and PH_3 fractions are the same (Figure 2a). Ohmic contacts can be established on p-doped InAsP and InAs.^{38,39} In the top segment of the nanowires, we measured by energy dispersive X-ray spectroscopy (EDS), a fraction of As in the NW increasing from 0 up to 0.56 ± 0.06 , which is in good accordance to the molar fractions used. We limited the As content in order to achieve good electrical contacts while maintaining the bandgap large enough as to lower the potential barrier toward the transition to InP where the recombination is intended to occur.

We evaluated the crystalline structure of the NW by TEM measurements (see Supporting Information S2). The growth direction switches from $\langle 100 \rangle$ to $\langle 111 \rangle$ during the transition from InP to InAsP. The $\langle 111 \rangle$ growth direction can be expected to be favored for InAsP NWs unless a careful optimization of growth parameters is accomplished. Here, the InAsP segment is used only as a contact segment and not as an active part of the nanowire devices. Because of the challenges in growing a gradual interface on both the bottom and top of a p-doped NW, we evaluated the performance of the gradual interface only in p-n junctions by measuring I - V characteristics of single nanowires. We grew the NWs in an n-InP/p-InP/p-InAsP growth sequence. To prevent InP noncatalyzed vapor-solid growth, which results in growth of low material quality on the nanowire side facets,⁴⁰ we introduced during growth in situ HCl with a molar fraction of 1.8×10^{-5} . However, no HCl was used during the InAsP growth, resulting in a shell that had to be removed after growth (see Supporting Information S1). Measurements on vertical as-grown nanowire devices have been demonstrated previously,⁴¹ but the gradual interface-related kinked morphology makes single vertical nanowire contacting impractical and array processing unfeasible (see Supporting Information). We thus transferred single nanowires to a Si/SiO₂ substrate for the electrical measurements and fabricated the metal contacts by two separate steps of electron beam lithography and metal evaporation. We used Ti/Au (110 nm/10 nm) for contacting the n-doped side of the NW and Ti/Pt/Au (1 nm/50 nm/60 nm) for contacting the p-doped side of the NW.

A typical two-point measurement, performed at room temperature, is shown in Figure 2b. We observed similar characteristics at low temperature, where most of the devices have higher voltage thresholds and sharper turn-ons of the

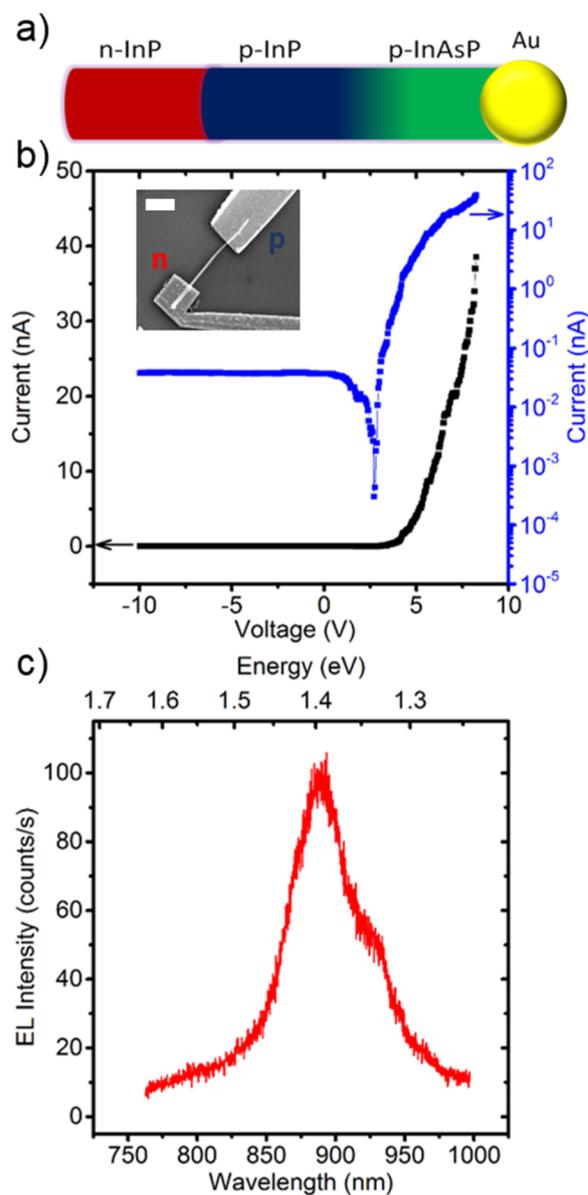


Figure 2. Optoelectronic characterization of p–n junctions based on $\langle 100 \rangle$ InP NWs with gradual interface. (a) Scheme of the geometry of single n-InP/p-InP/p-InAsP $\langle 100 \rangle$ NW with gradual interface. (b) I – V characterization in dark conditions at room temperature (293 K) of single $\langle 100 \rangle$ InP NW p–n junction with the previously described geometry. The current is shown in both a linear and logarithmic scale. Inset: SEM image of device used for NW optoelectronic characterization. Scale bar is 1 μm . (c) EL of single $\langle 100 \rangle$ InP NW p–n junction with gradual interface at 4 K, measured at an injection current of 700 nA. Nanowire diameter is 80 nm.

current. We attribute the relatively high turn-on voltage of 2.5 V to the low Zn doping concentration, which alters significantly the barrier voltage. No saturation of current is observed in the current and voltage range of our measurements (up to 15 V and 2.5 μA , which results in a current density in the order of 10^4 A/cm 2). The rectification ratio (measured in the range of ± 5 V) is typically 10^2 . We estimated a total series resistance in the device of 1 M Ω , dominated by the series resistance of the p-doped side, which is an improvement of 2 orders of magnitude compared to previous devices.⁴² The series resistance is of the same order of magnitude as the resistance measured for the

combination of single n-doped and p-doped nanowires, suggesting that ohmic contacts are obtained on both the n- and p-doped regions.

We tested the optoelectronic properties of the nanowire light-emitting diode by electroluminescence, measuring the emission spectrum as a function of the injection current. A typical electroluminescence (EL) spectrum of a single NW, measured at current of 700 nA at a temperature of 4K, is presented in Figure 2c (for more details, see Supporting Information S4). At room temperature, we observed a reduction in EL intensity of the peaks by an order of magnitude. In comparison with p–n junctions based on $\langle 111 \rangle$ InP nanowires without gradual interface,^{29,42} measured at similar injection currents, the nanowires presented in this work show an order of magnitude stronger peak intensity and narrower peak line-width by a factor of 2. The quantum efficiency at low temperatures is estimated to be $\sim 0.1\%$, further indicating an improvement with respect to previously reported devices.²⁹ At injection levels higher than this, the peak intensity area saturates, resulting in a lower quantum efficiency. Possible channel losses are minority carrier escape to the metal contacts, as the minority carrier diffusion length in InP is $> 1 \mu\text{m}$, and nonradiative recombination due to impurities. We expect the introduction of an undoped segment within the p–n nanowire diode to improve the quantum efficiency for applications of quantum devices. In addition, the nanowire is lying on a substrate with higher refractive index, so a large fraction of the light is directed toward the bottom and is not collected by the objective.⁴³ Nanowire integration in photonic waveguides can thus also enhance the light extraction efficiency.⁴⁴

Single nanowire devices have limited potential, though as nanowire position control on the wafer scale is essential to develop large-area NW-based devices. A high vertical yield and good reproducibility thus are necessary for future applications. To ensure reproducibility and sample uniformity, Au catalyst particles are patterned via nanoimprint lithography on a 2 inch wafer.^{45,46} To study the effect of the addition of dopants on the $\langle 100 \rangle$ InP NW growth, we grew p- and n-doped NW on Zn- and S-doped substrates, respectively. In both cases, we switched on the dopant precursor fluxes 10 s after InP growth initiated. At first, we determined the vertical yield, growth rate, and diameter by scanning electron microscopy to gain insight in the morphology of the samples. Using SEM images at 30° tilt, as can be seen in Figure 3a, we measured the growth rate and diameter by averaging at least 15 NWs per sample. For each sample, the vertical yield of five fields of 25×25 nanowires from different areas was measured by top-view SEM images (a typical image is shown in the inset of Figure 3a). Nonvertical nanowires are visualized easily in this configuration and include both nanowires growing in the $\langle 111 \rangle$ direction and nanowires crawling on the substrate. A very small percentage of gold droplets is absent ($< 0.01\%$), resulting in missing NWs in the pattern.

Varying dopant molar fractions over 3 orders of magnitude does not significantly influence the growth rate or the NW diameter, both in the case of Zn- and S-doped wires (see Supporting Information S5). However, the effect of the two dopant types on the vertical yield is completely different. A 3 orders of magnitude variation of the H $_2$ S molar fraction is not changing the vertical yield, which always remains higher than 85%. In contrast, the addition of a small molar fraction of DEZn, subsequently defined as [DEZn], significantly reduces the yield down to 15%. Upon increasing the [DEZn] (from

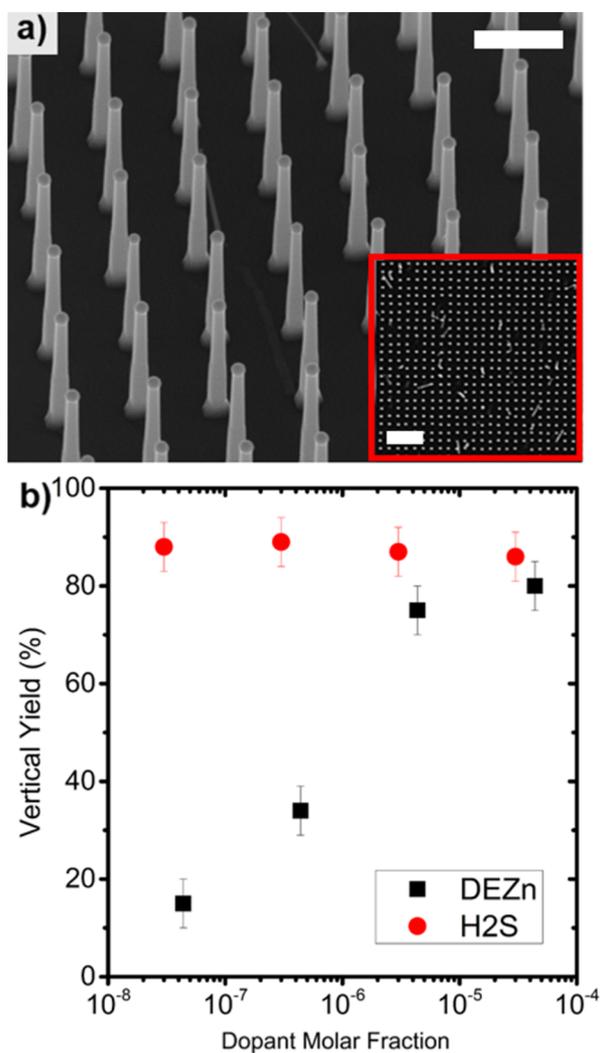


Figure 3. Vertical yield of impurity-doped $\langle 100 \rangle$ InP nanowires. (a) A 30° tilt SEM image of p-doped nanowires on p-doped InP substrate patterned by nanoimprint ($[\text{DEZn}] = 4 \times 10^{-4}$, growth conditions described in Supporting Information S1). Scale bar is 500 nm. Inset: Top-view SEM image of nanowires. Scale-bar is $2 \mu\text{m}$. (b) Vertical yield of nanowire growth as a function of H_2S (n-dopant) and DEZn (p-dopant) molar fractions.

$\sim 10^{-7}$ to 10^{-4}), the vertical yield increases from 15% to 80% (Figure 3b).

To investigate the effect of DEZn, we have studied p-doped nanowires with a short undoped stem, which have i-p doping profiles. We varied the growth time τ_i of the intrinsic segment before the introduction of the Zn dopant, always keeping a total growth time ($\tau_i + \tau_{\text{doped}}$) of 8 min. No HCl is used for this study to simplify the growth system, although we did not observe any significant effect on the yield when using HCl. We distinguish two cases: a low ($\sim 10^{-7}$) and a high ($\sim 10^{-4}$) $[\text{DEZn}]$. For low $[\text{DEZn}]$, the vertical yield increases from 15% to about 80% by increasing τ_i from 10 s to 3 min. When a high $[\text{DEZn}]$ is used, already a much higher (80%) yield is obtained for $\tau_i = 10$ s, and it increases up to 95% for $\tau_i = 3$ min (Figure 4a).

In order to find the origin of this difference, we have grown a similar series of undoped nanowires without adding the Zn-doped segment, so that the evolution of the catalyst can be studied. Growth times were between 10 s and 3 min, in analogy

to the previous growths. After the growth, we cooled down the sample under PH_3 fraction. We studied the contact angle between the gold particle and the nanowire by ex situ side-view SEM, as depicted in the inset of Figure 4b. The contact angle increases from 90 ± 5 to $\sim 125 \pm 5^\circ$ during the first 3 min of growth (Figure 4b). We expect the contact angle to stop increasing after 3 min as contact angles of about 125° have been shown to be ideal for vertical $\langle 100 \rangle$ NW growth. Subsequently, the contact angles have been determined for samples grown with different $[\text{DEZn}]$ with $\tau_i = 10$ s and terminating the growth after 3 min. We chose $\tau_i = 10$ s as the variation of $[\text{DEZn}]$ has the largest effect at this value. The contact angle increases from 97 ± 3 to $117 \pm 7^\circ$ with increasing DEZn molar fraction (Figure 4c). In Figure 4d, we plot the vertical yield versus the contact angle, measured on the same sample: a clear correlation can be observed with the vertical yield increasing with contact angle.

Contact angles in the range of 120 – 130° have been previously shown to be optimal for vertical growth of undoped $\langle 100 \rangle$ NW, because they are close to the dynamic equilibrium of the particle, resulting in stable growth in the $\langle 100 \rangle$ direction.²³ The increase of the vertical yield with longer τ_i is thus also explained. A longer τ_i results in a larger contact angle due to the natural evolution of the catalyst particle, which is caused by the line tension, as has been shown previously.⁴⁷ Increasing τ_i therefore promotes high vertical yield. Introducing a small amount of DEZn in the early stages of the growth destabilizes the Au droplet, which is very sensitive to any perturbation, causing a reduction in vertical yield. It has already been demonstrated that dopants change the contact angle and the surface energy of catalyst that in this case is Au–In–(Zn,S)^{48–50} but these influences have not been unambiguously quantified yet. Our hypothesis originates in the kinetics of VLS growth. We considered a simple model of the catalyst with cylindrical symmetry, similar to what has been proposed previously.⁴⁸ Our system is governed by Young's equation at the triple-phase boundary, based on the interplay between surface energies. The addition of Zn is expected to influence all surface energies (γ_{LS} , γ_{LV} , and γ_{SV} , respectively, liquid–solid, liquid–vapor, and solid–vapor). In particular, it is important to point out the influence of Zn on γ_{SV} , which has not been considered extensively before. It has already been demonstrated that DEZn can modify the surface of InP substrates, thus affecting γ_{SV} ;^{51,52} in our case, we expect DEZn to destabilize the catalyst, in particular by increasing its wetting and resulting in a smaller contact angle, by modifying the termination of the $\langle 100 \rangle$ InP substrate. There are two contrasting mechanisms expected to act on the catalyst: the first, crucial at high $[\text{DEZn}]$, promotes high vertical yield by increasing the catalyst volume and thus the contact angle and affecting the liquid–vapor and liquid–solid interfaces. The second is the effect of DEZn on the surface of InP, which is more significant at low $[\text{DEZn}]$ (see Supporting Information S6 for more details). A comprehensive explanation of this phenomenon is beyond the scope of our paper; more detailed studies using, for example, in situ TEM⁵³ are necessary to conclude definitively on the precise mechanism. A high vertical yield growth of $\langle 100 \rangle$ NWs with a wide range of $[\text{DEZn}]$ is possible either by growing a relatively short intrinsic stem or by using large $[\text{DEZn}]$. Also, growth of Zn-doped nanowires on S-doped stems behaves in the same way as the growth previously described on undoped segments, making straightforward growing p–n (n–p) junctions.

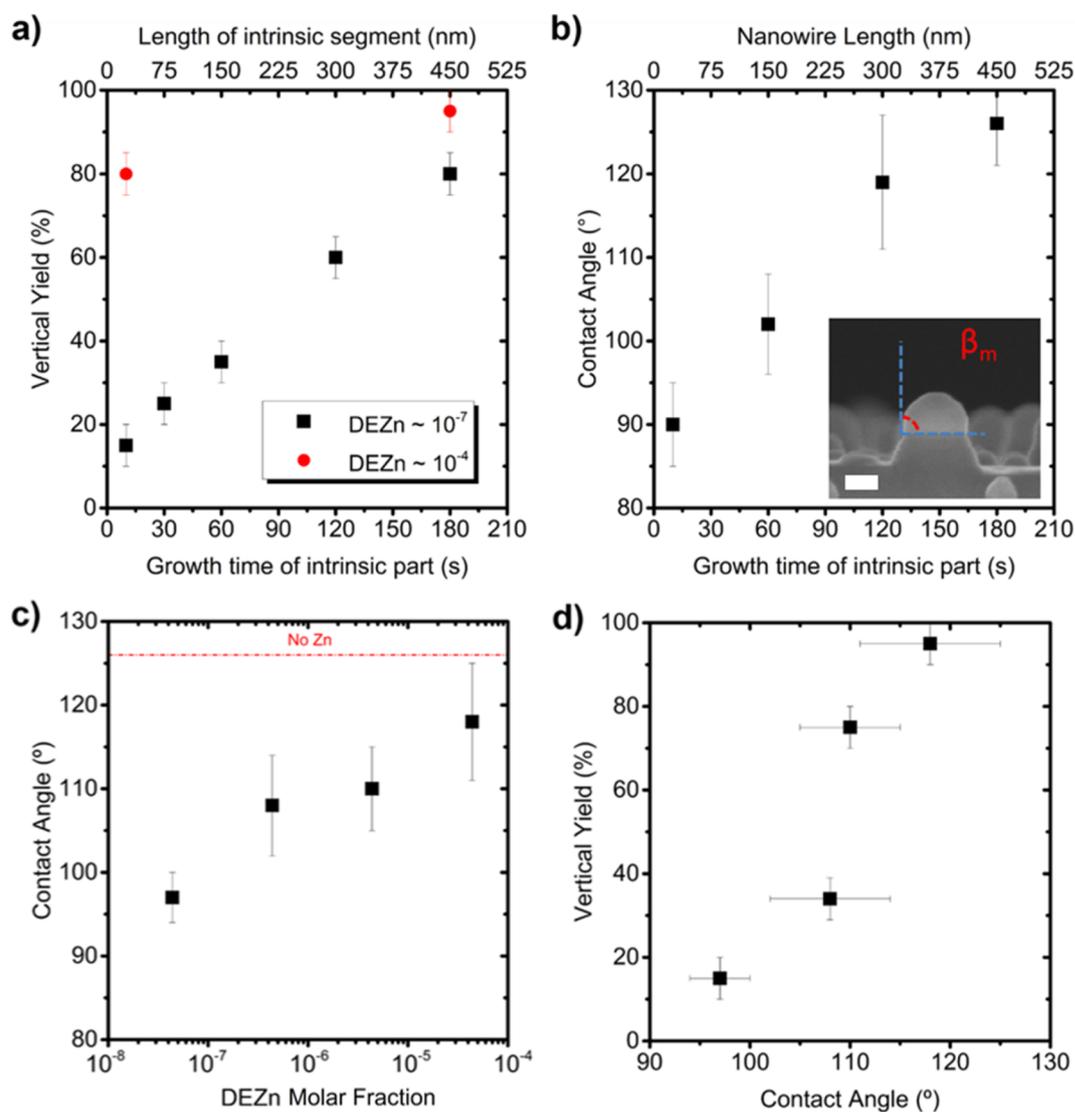


Figure 4. Effect of DEZn on the growth of $\langle 100 \rangle$ InP NW. (a) Structure: i-p NW with variable τ_i . Vertical yield of NW with undoped/p-doped segments as a function of τ_i (the growth time of the undoped stem) varied from 10 s to 3 min. (b) Structure: i-NW with variable length. Contact angle of i-InP NW without p-doped segment as a function of τ_i in the same range as panel (a). Inset shows side-view SEM image used to measure ex situ the contact angle between gold particle and NW. Scale bar is 50 nm. (c) Structure: i-p NW with $\tau_i = 10$ s and variable DEZn molar fraction. Contact angle as a function of [DEZn] with $\tau_i = 10$ s. Red dash dot line indicates contact angle if no Zn is introduced. (d) Nanowire vertical yield as a function of contact angle, measured on the same sample as panel (c).

In conclusion, we have demonstrated the first p–n junction based on single-crystalline $\langle 100 \rangle$ -oriented nanowires and measured its optoelectronic properties in a single-nanowire device. A low resistive contact to p-doped InP has been realized by developing a novel p-InP/p-InAsP gradual interface. To achieve optimal reproducibility and sample uniformity, we have investigated how to obtain high vertical yield of Au-catalyzed p- and n-doped InP NWs grown in the $\langle 100 \rangle$ direction. We found that different DEZn molar fractions affect the contact angle between the catalyst droplet and the nanowire. A large contact angle results in a high vertical yield. The $\langle 100 \rangle$ nanowires show great potential for next-generation optoelectronics and energy conversion applications, which are integrated with the current semiconductor technology.

■ ASSOCIATED CONTENT

📄 Supporting Information

The Supporting Information is available free of charge on the ACS Publications website at DOI: 10.1021/acs.nanolett.6b00203.

Nanowire growth conditions; optoelectronic characterization processing and measurements; SEM and TEM characterization details; gradual interface structural characterization; and doped nanowires growth rate and Zn influence additional discussion. (PDF)

■ AUTHOR INFORMATION

Author Contributions

A.C. and J.W. contributed equally to this work.

Notes

The authors declare no competing financial interest.

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